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COMPOSITE MATERIAL FOR EMI/EMP HARDENING

PROTECTION IN MARINE ENVIRONMENTS

TO ALL WHOM IT MAY CONCERN

BE IT KNOWN THAT (1) DAVID S. DIXON employee of the United States Government and (2) JAMES V. MASI, citizens of the United States of America and residents of (1) Old Lyme, County of New London, State of Connecticut and (2) Wilbraham, County of Hampden, Commonwealth of Massachusetts have invented certain new and useful improvements entitled as set forth above of which the following is a specification:

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COMPOSITE MATERIAL FOR EMI/EMP HARDENING PROTECTION
IN MARINE ENVIRONMENTS

This patent application is co-pending with related patent application entitled "Method for Providing EMI/EMP Hardening and Breakdown Protection in Composite Materials" by the same inventors filed on the same date as this application.

STATEMENT OF GOVERNMENT INTEREST

The invention described herein may be manufactured and used by or for the Government of the United States of America for governmental purposes without the payment of any royalties thereon or therefor.

BACKGROUND OF THE INVENTION

(1) Field of the Invention

The present invention relates to conductive composite materials and more particularly to composite materials for shielding against the effects of EMI/EMP in corrosive marine environments.

(2) Description of the Prior Art

It is well known that existing methods of improving the electromagnetic interference (EMI) and electromagnetic pulse (EMP) performance of lightweight non-corrosive, non-metallic materials, so often used in today's commercial and military
enclosures, have typically utilized coatings, platings and/or separate metallic layers. Coatings and platings on present non-metallic materials have not provided acceptable solutions in the areas of material adhesion, adequate shielding effectiveness and material electrochemical compatibility when interfaced with other materials. Hybrid connectors consisting of independent metal and plastic layers may provide a measure of EMI/EMP performance. This approach, however, incurs increased material/connector complexity and weight.

SUMMARY OF THE INVENTION

Accordingly, it is a general purpose and object of the present invention to provide a conductive composite material for use as an electromagnetic shield.

It is a further object that such material be lightweight.

Another object is that such material exhibit a high level of corrosion resistance in a marine environment.

Still another object is that such material be easily formed and machined into electrical enclosures.

These objects are accomplished with the present invention by providing composite materials comprising conducting and semi-conducting particles, fibers, or flakes in a matrix of polymeric or ceramic material for use in connectors, junction boxes, enclosures or similar electromagnetic shielding applications. The use of a composite material with electromagnetic shielding properties built into the material
itself, combined with the use of a semi-conductive filler that 
minimizes the corrosive effect of electrochemical potential 
differences, provides EMI/EMP shielding and corrosion resistance 
in these materials when they are used in the presence of marine 
and aircraft environments. Oxide semiconductor materials and 
compatible conductive fillers provide a new class of EMI/EMP 
composite materials that exhibit a stable current-controlled and 
voltage-controlled negative resistance (VCNR/CCNR) 
characteristic. Testing has shown that the conductivities of 
these materials increase as the field and/or the voltage 
increases. This characteristic is desirable to provide inherent 
protection of electronic circuits from voltages or currents. The 
VCNR/CCNR effect is dependent upon the voltages, the degree of 
filler material combinations and the filler loading which will 
determine the composite materials properties.

BRIEF DESCRIPTION OF THE DRAWINGS

A more complete understanding of the invention and many of 
the attendant advantages thereto will be readily appreciated as 
the same becomes better understood by reference to the following 
detailed description when considered in conjunction with the 
accompanying drawings wherein:

FIG. 1 shows the electromagnetic shielding effectiveness 
(S.E.) of various composite materials based on tests using the 
ASTM testing method.

FIG. 2 shows the VCNR/CCNR effect that is occurring in
samples of the composite appropriately doped with semiconductive filler.

DESCRIPTION OF THE PREFERRED EMBODIMENT

FIG. 1 illustrates the electromagnetic shielding effectiveness (S.E.) of various composite materials using the ASTM testing method. This method evaluated the near field S.E. of a material. This figure indicates that the 15%ITO/10%Ni-Flake S.E. is as good as a 40% loading of Ni-coated graphite, however unlike the Ni-coated graphite the ITO/Ni-Flake composite also protects against corrosion caused by electrochemical potential differences by rapidly reducing the electrochemical potential difference (ECPD) between dissimilar materials.

FIG. 2 illustrates the VCNR/CCNR effect that is occurring in samples of the composite appropriately doped with semiconductive filler. In this sample the 15%ITO/10% Ni-Flake composites resistance decreased from .95 Ohms to less than .7 Ohms as the applied voltage was increased from .2 millivolts to 8 millivolts over a frequency range from 10 kHz to 10 MHz.

The composite material is comprised of a filler/resin combination wherein the filler is molded into the resin. One of the more desirable resins utilized is polyether etherketone (PEEK) because of its good moldability, good to excellent machinability, its good continuous use temperature (exceeds 220 degrees Celsius when loaded) and its resistance to chemicals and to thermal and mechanical shock. Studies are also being
For the case of the ITO/Nickel Flake in PEEK the 15 weight-percent (w/%) ITO powder (10%SnO₂/90%In₂O₃, from Indium Corporation of America) was blended with 10 w/% Nickel Flake (from Novamet, International Nickel Corp.) and further blended into a PEEK polymer (from ICI America). The resulting mixture was extruded at a temperature in excess of 250 degrees Celsius. This extruded material was then granulated and used as feeder stock for injection molding at temperatures in excess of 165 degrees Celsius.

In the case of the ITO/Nickel Flake/Intr. conductive polymer in polycarbonate the same percentages of ITO and Ni Flake described above were also blended into a Polycarbonate material (from Buehler, Ltd., General Electric) that also had 10 w/% intrinsically conducting polymer (ICP 117 from Polaroid Corp.) added. This blend was compression molded at 180 degrees Celsius and 200 p.s.i. into a test sample.

In the case of the ITO/Nickel Flake in polycarbonate the same percentages of ITO and Ni Flake as above were blended as above in polycarbonate and were compression molded as above but without the intrinsically conducting polymer.

The composite material is designed to satisfy a full range of electromagnetic, chemical and mechanical properties, including corrosion resistance to hostile environments, with emphasis placed on electrochemical compatibility with connecting enclosures of aluminum.
The mechanical properties of a composite depend upon the relative proportions of resin and filler, and the size, shape, state of aggregation or agglomeration, relative dispersion, and orientation of filler. Further, the level of interphase adhesion affects ultimate strength and elongation of the material and provides a measure of the unwanted condition known as "pull away". For example, for fibers with a circular or square cross-section a simplified method for predicting the tensile and transverse modulus of elasticity for a composite is to employ the Halpin-Tsai equations, i.e.,

**Tensile:**

\[
E_c(\text{ten.}) = V_f E_f + V_m E_m, \tag{1}
\]

and

**Transverse:**

\[
E_c(\text{tran.}) = \frac{(1 + 2nV_f)/(1 - nV_f)}{E_m} \tag{2}
\]

where \( n = [(E_f/E_m) - 1]/[(E_f/E_m) + 2] \), \( E_c \) is the modulus of the composite, \( E_f \) and \( E_m \) are the moduli of the filler and the matrix, respectively, and \( V_f \) and \( V_m \) are the volume fractions of the filler and matrix, respectively. Equations (1) and (2) represent the basis upon which the mechanical properties of the desired composite are predicted.

There are a number of prior art theoretical models which conditionally predicted the electrical properties of composites. These models were based upon the hopping model taught in Mott, N.F., Adv. Phys. (Philos. Mag. Suppl.), 16:49 (1967), the percolation theory taught in McCullough, R.L., Composites Science

The present invention establishes a verifiable model which predicts the electromagnetic properties of a composite when provided with a set of specific component material parameter inputs. The total impedance $Z_{\text{total}}$ of a three dimensional distributed network of equivalent impedances $Z_{\text{equiv.}}$ can be shown to be,

$$Z_{\text{total}} = \frac{m Z_{\text{equiv.}}}{16} \quad (3)$$

where:

- $m$ is the aspect ratio of length to width of a particular test specimen and $Z_{\text{equiv.}}$ is the equivalent impedance of the particle/matrix combination. The equivalent impedance $Z_{\text{equiv.}}$ is calculated based upon the schematic of the resistor, capacitor, and inductor circuit shown in FIG. 1.

- Using the filler model which relates the resistivity of the filler material to that of the composite via the volume fraction of the filler, the resistivity of the combination can be calculated, theoretically, for these small interparticle dimensions.

$$\rho = \frac{V_f}{3}[1/(1 - (\sqrt{V_f})/3)]\rho_o \quad (4)$$

Using form factors for the particle, flake, or fiber, and combining this with a three-dimensional polymer matrix, leads to
a solvable set of equations involving resistors, capacitors, and
inductors at various frequencies and fields. The model needs
inputs with respect to the electric field and the frequency
dependence of the resistive and reactive elements, i.e. $R(E,\omega)$
and $X(E,\omega)$.

A composite sample under an applied field has its potential
distribution curves bent more drastically over the conducting
filler contacts due to space charge. For purposes of simplicity,
the particle/flake/fiber is assumed to have smooth contours and
the polymer matrix is electrically homogeneous and isotropic.
A number of researchers have noted that current controlled
negative resistance (CCNR) is observed (voltage dependent
threshold initiation) Pike, J.N., Private Communication, UCRI 618
(1970), p. 155. Local heating of the matrix/conductive filler is
deemed to be the cause, the result being quasi-filamentary
conduction. This implies that, as the voltage (field) increases
across such a composite element, the conductivity and, as a
result the shielding effectiveness, increases. This effect is
enhanced by certain fillers, such as semiconductive oxides which
themselves exhibit CCNR or voltage controlled negative resistance
(VCNR).

According to the electrical model shown (ignoring for now
the aforementioned inductive component which is negligible for
frequencies under 50 MHz), the equivalent $Ro/R(E,\omega)/C(E,\omega)$
circuit impedance decreases with increasing frequency. This,
combined with CCNR or VCNR, indicates that the composite with
semiconducting particles, flakes, or fibers (or combinations thereof) is an improved shield, not only for EMI, but also for EMP applications. The electromagnetic properties are predicted by the model set forth in our co-pending patent application.

The resistivity of the composite material ranges between $1 \times 10^{-3}$ and $1 \times 10^{-5}$ Ohm/cm. This places it at the higher end of the metal resistivity spectrum but below the resistivity characteristics of typical carbon powders and fibers so often used in composites. Figure (1) shows that the shielding effectiveness of the composite material using 15% ITO/10%Ni flakes compares quite favorably with that of 15% Ni coated graphite with the added benefit of not having an electrochemical corrosion problem.

The electrochemical potential of the ITO and ITO/Ni flake fillers were measured in a flowing brine solution versus 5000 series aluminum. The tests revealed that the potential difference for each filler decreased substantially after 15 seconds. Initial electrochemical voltages between aluminum and nickel in a brine solution were around 1.25 volts which decreased to approximately .2 Volts after about 15 seconds. Figure (2) shows that some mixtures of the composite material may also be suitable for use as a breakdown material against electromagnetic pulse surges. This is the VCNR and CCNR effect discussed earlier.

It will be understood that various changes in the details, materials, steps and arrangement of parts, which have been herein
described and illustrated in order to explain the nature of the
invention, may be made by those skilled in the art within the
principle and scope of the invention as expressed in appended
claims.

The advantages of the present invention over the prior art
are that lightweight, easily formable composite materials may be
used in place of metals without suffering the effects of EMI/EMP.

What has thus been described are composite materials
composed of conducting and semi-conducting particles, fibers, or
flakes in a matrix of polymeric material for use in connectors,
junction boxes, enclosures or similar electromagnetic shielding
applications. Only the use of a composite material with
electromagnetic (EM) shielding properties built into the material
itself, combined with the use of a semi-conductive filler that
will minimize the corrosive effect of electrochemical potential
differences, will provide a total long-term solution to ensure
that EM shielding and corrosion resistance is maintained in these
materials when they are used in the presence of marine and
aircraft environments.

Oxide semiconductor materials and compatible conductive
fillers also provide a basis for a new class of EMI and EMP
composite materials that exhibit a stable current-controlled and
voltage-controlled negative resistance (VCNR, CCNR)
characteristic. Testing has shown that the conductivities of
these materials increase as the field and/or the voltage
increases. This characteristic is desirable to provide inherent
protection of electronic circuits from voltages or currents.

This VCNR/CCNR effect is dependent upon the voltages, the degree of filler material combinations and the filler loading which will determine the composite materials properties.

Obviously many modifications and variations of the present invention may become apparent in light of the above teachings.
COMPOSITE MATERIAL FOR EMI/EMP HARDENING PROTECTION
IN MARINE ENVIRONMENTS

ABSTRACT OF THE DISCLOSURE

Composite material composed of conducting and semi-conducting oxide particles, fibers, or flakes suspended in a polymeric material matrix for use in connectors, junction boxes, enclosures or similar electromagnetic shielding applications. The use of a composite material with electromagnetic shielding properties built into the material itself, combined with the use of a semi-conductive filler that minimizes the corrosive effect of an electrochemical potential difference, provides EM shielding and corrosion resistance for these materials when they are used in marine and aircraft environments. Oxide semiconductor materials and compatible conductive fillers also provide a basis for a new class of EMI and EMP composite materials that exhibit a stable current-controlled and voltage-controlled negative resistance (VCNR, CCNR) characteristic. Testing has shown that the conductivities of these materials increase as the field and/or the voltage increases. This characteristic is desirable, providing inherent protection of electronic circuits from voltages or currents. This VCNR/CCNR effect is dependent upon the voltages, the degree of filler material combinations and the filler loading which will determine the composite materials properties.
FIG. 1

Legend

- 40% Al Flake
- 15% Ni Coated
- 40% Ni Coated
- 40% Carbon
- 15% InSnOx/Carbon
- 10% Ni Flake

Shielding Effectiveness (dB Power)

Frequency (MHz x 1000)

FIG. 2

Legend

- 0.0002 V
- 0.001 V
- 0.008 V

Resistance (Ohms)

Frequency (MHz)

FIG. 1

FIG. 2